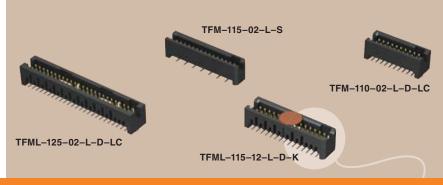


(1,27mm) .050" TFM, TFML SERIES





SMT HIGH RELIABILITY HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TFM or www.samtec.com?TFML

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Plating: Au or Sn over 50μ" (1,27μm) Ni Voltage Rating:
350 VAC mated with SFM
Operating Temp Range:
-55°C to +125°C

RoHS Compliant: Yes

CURRENT RATING	
TFM/SFM	
5A	
4.5A	
3.9A	
2.6A	

6 POSITIONS (2x3) POWERED

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (05-25) (0,15mm) .006" max (30-50)

APPLICATION SPECIFIC OPTION

Solder nail option for (2,36mm) .093" thick board available. Call Samtec.

Note: Other Gold plating options available. Contact Samtec.

Note:

Some sizes, styles and options are non-standard, non-returnable.

Mates with: SFM, SFMC, **SFSD**

TFMI Mates with: SFML, SFSD (-XL option), SFSDT (–XL option)

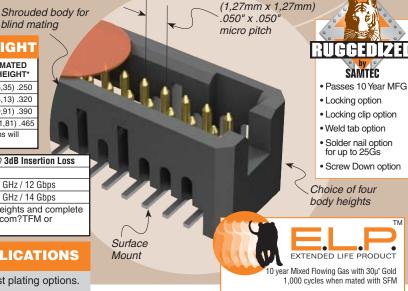


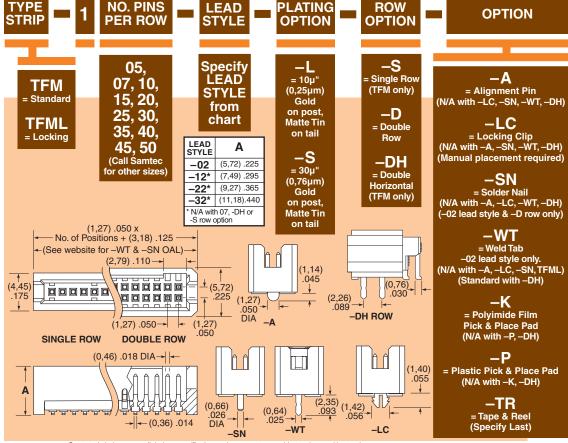
1,27mm SFM/TFM	Rated @ 3dB Insertion Loss
6,35mm Stack Height	
Single-Ended Signaling	6.0 GHz / 12 Gbps
Differential Pair Signaling	7.0 GHz / 14 Gbps
Performance data for other stack heights and complete	

test data available at www.samtec.com?TFM or contact sig@samtec.com

COST-SAVING APPLICATIONS

See TFC Series for lower cost plating options.





Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM